MB05F THRU MB10F

REVERSE VOLTAGE: 50 to 1000 VOLTS FORWARD CURRENT: 0.5 AMPERE

FEATURES

· Surge overload rating: 30 amperes peak

· Ideal for printed circuit board

· Plastic material has Underwriters Laboratory Flammability Classification 94V-0

· Low leakage

· Reliable low cost construction utilizing molded

MECHANICAL DATA

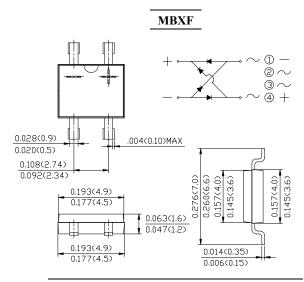
Case: Molded plastic, MBXF

Epoxy: UL 94V-O rate flame retardant

Terminals: Leads solderable per MIL-STD-202,

method 208 guaranteed Mounting position: Any

Weight: 0.00528ounce, 0.134gram



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

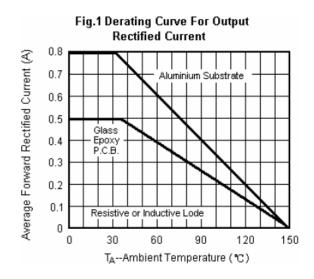
	Symbols	MB05F	MB1F	MB2F	MB4F	MB6F	MB8F	MB10F	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current			•	•	•	•	•	•	
(see Fig. 1) on glass-epoxy P.C.B (Note 2)	I _(AV) 0.5 0.8							Amp	
on aluminum substrate (Note 3)									
Peak Forward Surge Current,									
8.3ms single half-sine-wave	I _{FSM} 30						Amp		
superimposed on rated load (JEDEC method)									
Maximum Forward Voltage	$\mathbf{V_F}$	1.0							Volts
at 0.4A DC and 25 ℃	V F								
Maximum Reverse Current at T _A =25℃	I_R	5.0 500							uAmp
at Rated DC Blocking Voltage T _A =125°C	1 _R								
Typical Junction Capacitance (Note 1)	C _J				13				pF
Typical Thermal Resistance (Note 3)	$R_{\theta JA}$				60				°C/W
Typical Thermal Resistance (Note 2)	$R_{\theta JL}$				16				°C/W
Operating and Storage Temperature Range	T _J , Tstg				-55 to +150	0			°C

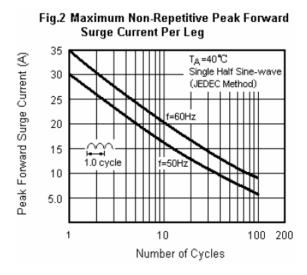
NOTES:

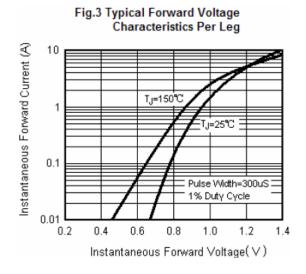
- 1- Measured at 1 $\mbox{MH}_{\mbox{\scriptsize Z}}$ and applied reverse voltage of 4.0 VDC.
- 2- On glass epoxy P.C.B. mounted on 0.05 x 0.05" (1.3 x 1.3mm) pads
- 3- On aluminum substrate P.C.B. with an area of 0.8" x 0.8" (20 x 20mm) mounted on 0.05 x 0.05" (1.3 x 1.3mm) solder pad

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Characteristic Curves (TA=25 \mathcal{C} unless otherwise noted)







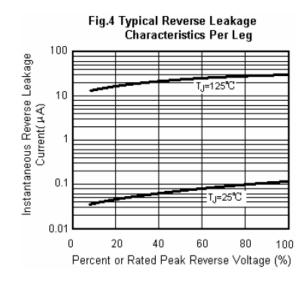


Fig.5 Typical Junction Capacitance Per Leg 30 Junction Capacitance (pF) TJ=25℃ f=1.0MHz 25 Vsig=50mVp-p 20 15 10 5.0 0 0.1 10 100 200 Reverse Voltage (v)